

## BCM857BV

PNP/PNP matched double transistor

4 July 2023

Product data sheet

### 1. General description

PNP/PNP matched double transistor in an an ultra small and flat lead SOT666 Surface-Mounted Device (SMD) plastic package. The transistors are fully isolated internally.

### 2. Features and benefits

- Current gain matching
- Base-emitter voltage matching
- Drop-in replacement for standard double transistors

### 3. Applications

- Current mirror
- Differential amplifier

### 4. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transisto	r						
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	-45	V
I <sub>C</sub>	collector current			-	-	-100	mA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C		200	290	450	
Per device							
h <sub>FE1</sub> /h <sub>FE2</sub>	DC current gain matching	$V_{CE}$ = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C	[1]	0.9	1	-	
$V_{BE1}-V_{BE2}$	base-emitter voltage matching		[2]	-	-	2	mV

[1] The smaller of the two values is taken as the numerator.

[2] The smaller of the two values is subtracted from the larger value.

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### 5. Pinning information

Table 2	. Pinning info	ormation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	6 5 4	C1 B2 E2
2	B1	base TR1		
3	C2	collector TR2		$\begin{pmatrix} \downarrow \downarrow TR2 \\ TR1 \downarrow \downarrow TR2 \end{pmatrix}$
4	E2	emitter TR2		
5	B2	base TR2		E1 B1 C2
6	C1	collector TR1	SOT666	sym018

### 6. Ordering information

#### Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BCM857BV	SOT666	plastic, surface-mounted package; 6 leads; 0.5 mm pitch; 1.6 mm x 1.2 mm x 0.55 mm body	<u>SOT666</u>

### 7. Marking

Table 4. Marking codes	
Type number	Marking code
BCM857BV	3в

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transist	or	1	L.			
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-50	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-45	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-5	V
I <sub>C</sub>	collector current			-	-100	mA
I <sub>CM</sub>	peak collector current	t <sub>p</sub> ≤ 1 ms; single pulse		-	-200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] [2]	-	200	mW
Per device	'		·			
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] [2]	-	300	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

BCM857BV

### 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per transist	or						
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	625	K/W
Per device							
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	416	K/W

Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. [1]

Reflow soldering is the only recommended soldering method. [2]

### **10.** Characteristics

#### **Table 7. Characteristics**

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transisto	or						
I <sub>CBO</sub>	collector-base cut-off	V <sub>CB</sub> = -30 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	-15	nA
	current	V <sub>CB</sub> = -30 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	-5	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = -5 V; I <sub>C</sub> = -10 µA; T <sub>amb</sub> = 25 °C		-	250	-	
		$V_{CE}$ = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C		200	290	450	
V <sub>CEsat</sub>	collector-emitter	$I_{C}$ = -10 mA; $I_{B}$ = -0.5 mA; $T_{amb}$ = 25 °C		-	-50	-200	mV
	saturation voltage	I <sub>C</sub> = -100 mA; I <sub>B</sub> = -5 mA; T <sub>amb</sub> = 25 °C		-	-200	-400	mV
V <sub>BEsat</sub>	base-emitter saturation	$I_{C}$ = -10 mA; $I_{B}$ = -0.5 mA; $T_{amb}$ = 25 °C	[1]	-	-760	-	mV
	voltage	I <sub>C</sub> = -100 mA; I <sub>B</sub> = -5 mA; T <sub>amb</sub> = 25 °C	[1]	-	-920	-	mV
V <sub>BE</sub>	base-emitter voltage	$V_{CE}$ = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C	[2]	-600	-650	-700	mV
		V <sub>CE</sub> = -5 V; I <sub>C</sub> = -10 mA; T <sub>amb</sub> = 25 °C	[2]	-	-	-760	mV
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	-	2.2	pF
C <sub>e</sub>	emitter capacitance	V <sub>EB</sub> = -0.5 V; I <sub>C</sub> = 0 A; i <sub>c</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	10	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -10 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C		100	175	-	MHz
NF	noise figure	$V_{CE}$ = -5 V; I <sub>C</sub> = -0.2 mA; R <sub>S</sub> = 2 kΩ; f = 10 kHz to 15.7 kHz		-	1.6	-	dB
		V <sub>CE</sub> = -5 V; I <sub>C</sub> = -0.2 mA; f = 1 kHz; B = 200 Hz		-	3.1	-	dB
Per device							
h <sub>FE1</sub> /h <sub>FE2</sub>	DC current gain matching	$V_{CE}$ = -5 V; I <sub>C</sub> = -2 mA; T <sub>amb</sub> = 25 °C	[3]	0.9	1	-	
V <sub>BE1</sub> -V <sub>BE2</sub>	base-emitter voltage matching	-	[4]	-	-	2	mV

 $V_{BEsat}$  decreases by about 1.7 mV/K with increasing temperature.  $V_{BE}$  decreases by about 2 mV/K with increasing temperature. [1]

[2]

[3] The smaller of the two values is taken as the numerator.

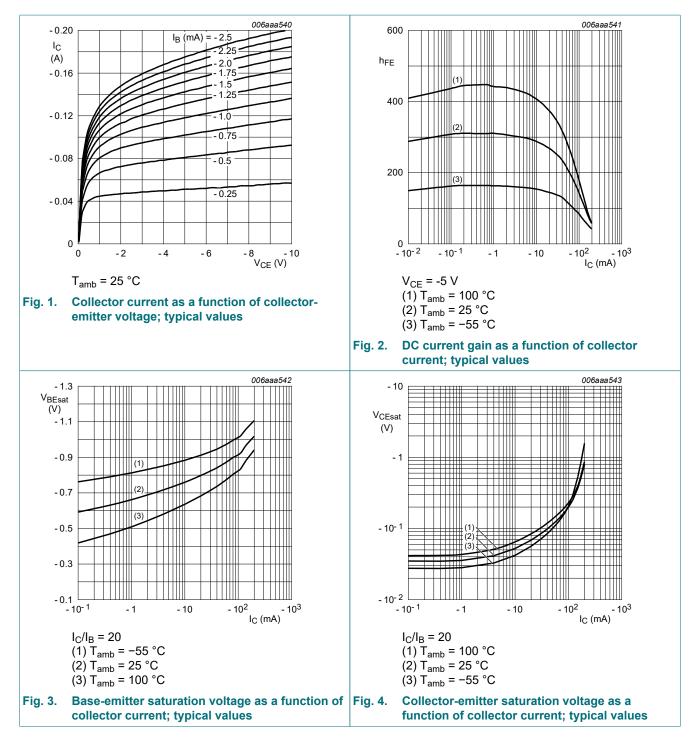
The smaller of the two values is subtracted from the larger value. [4]

BCM857BV

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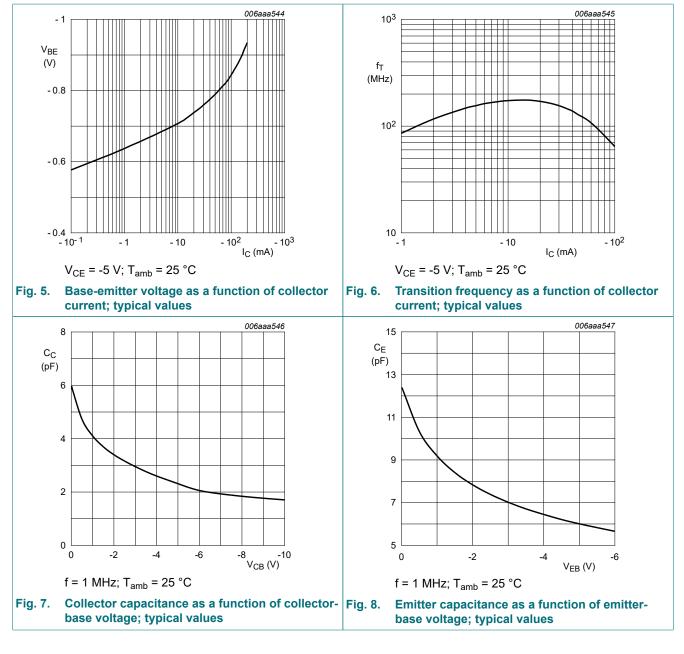
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#### **PNP/PNP** matched double transistor

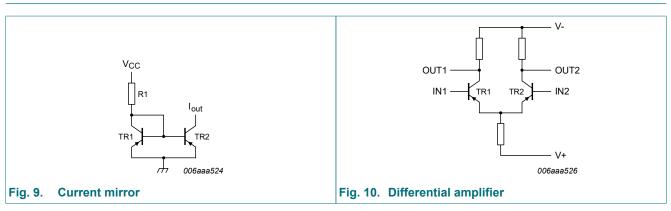


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#### **PNP/PNP** matched double transistor



### **11. Application information**

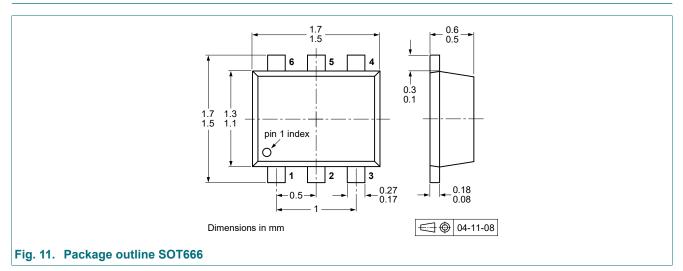


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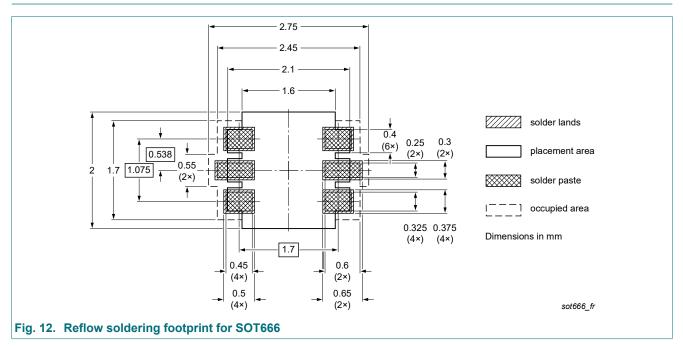
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### 12. Package outline



### 13. Soldering



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### 14. Revision history

Table 8. Revision histo	ry						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
BCM857BV v.7	20230704	Product data sheet	-	BCM857BV_BS_DS_6			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Family data sheet splitted to single type data sheets.</li> <li>Section "Packing information" removed.</li> </ul>						
BCM857BV_BS_DS_6	20090828			BCM857BV_BS_DS_5			
BCM857BV_BS_DS_5	20060627	Product data sheet	-	BCM857BS_DS_4			
BCM857BS_DS_4	20060216	Product data sheet	-	BCM857BS_DS_3			
BCM857BS_DS_3	20060130	Product data sheet	-	BCM857BS_2			
BCM857BS_2	20050411	Product data sheet	-	BCM857BS_1			
BCM857BS_1	20040914	Product data sheet	-	-			

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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#### **PNP/PNP** matched double transistor

### Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	.2
6.	Ordering information	.2
7.	Marking	2
8.	Limiting values	2
9.	Thermal characteristics	3
10.	Characteristics	3
11.	Application information	.5
12.	Package outline	6
13.	Soldering	6
14.	Revision history	.7
15.	Legal information	.8

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